

$V_{DS}$	=	3300V
$R_{DS(on)}$	=	120mΩ
$I_D@25\text{ }^\circ\text{C}$	=	33A

## Features

- High Blocking Voltage with Low On-Resistance
- High Speed Switching with Low Capacitance
- Easy to Parallel and Simple to Drive

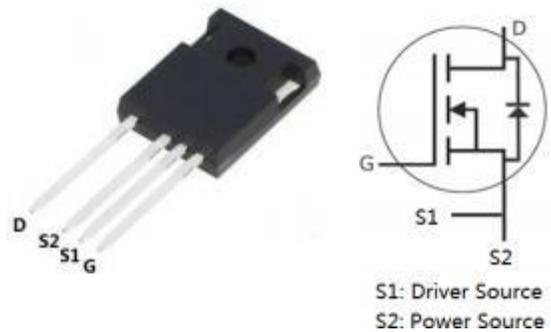
## Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

## Applications

- Power Supplies
- High Voltage DC/DC Converters
- Motor Drives
- Switch Mode Power Supplies
- Pulsed Power Applications

## Package



Part Number	Package
YX330R120	TO-247-4

## Maximum Ratings ( $T_c=25\text{ }^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Value	Unit	Test Conditions	Note
$V_{DSmax}$	Drain- Source Voltage	3300	V	$V_{GS}=0V, I_D=100\mu A$	
$V_{GSmax}$	Gate- Source Voltage	-10/+25	V	Absolute maximum values	
$V_{GSop}$	Gate- Source Voltage	-5/+20	V	Recommended operational values	
$I_D$	Continuous Drain Current	33	A	$V_{GS}=20V, T_c=25\text{ }^\circ\text{C}$	Fig. 15
		24		$V_{GS}=20V, T_c=100\text{ }^\circ\text{C}$	
$I_{D(pulse)}$	Pulsed Drain Current	100	A	Pulse width $t_p$ limited by $T_{Jmax}$	Fig. 14
$P_D$	Power Dissipation	366	W	$T_c=25\text{ }^\circ\text{C}$ ,	Fig. 16
$T_J, T_{STG}$	Operating Junction and Storage Temperature	-55 to +175	$^\circ\text{C}$		

## Electrical Characteristics (T<sub>c</sub>=25 °C unless otherwise specified)

Symbol	Parameter	Min.	Typ.	Max.	Unit	Test Conditions	Note
V <sub>(BR)DSS</sub>	Drain- Source Breakdown Voltage	3300	/	/	V	V <sub>GS</sub> =0V, I <sub>D</sub> =100μA	
V <sub>GS(th)</sub>	Gate Threshold Voltage	2.5	3.5	/	V	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =4mA	Fig. 9
		/	2.4	/		V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =4mA, T <sub>J</sub> =175 °C	
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	/	1		μA	V <sub>DS</sub> =3300V, V <sub>GS</sub> =0V	
I <sub>GSS+</sub>	Gate- Source Leakage Current	/	10	100	nA	V <sub>DS</sub> =0V, V <sub>GS</sub> =25V	
I <sub>GSS-</sub>	Gate- Source Leakage Current	/	10	100	nA	V <sub>DS</sub> =0V, V <sub>GS</sub> =-10V	
R <sub>DS(on)</sub>	Drain- Source On-State Resistance	/	120	156	mΩ	V <sub>GS</sub> =20V, I <sub>D</sub> =15A	Fig.5-8
		/	251	/		V <sub>GS</sub> =20V, I <sub>D</sub> =15A, T <sub>J</sub> =175 °C	
g <sub>fs</sub>	Transconductance	/	6.0	/		V <sub>DS</sub> =10V, I <sub>D</sub> =15A	Fig.4
		/	6.5	/	V <sub>DS</sub> =10V, I <sub>D</sub> =15A, T <sub>J</sub> =175 °C		
C <sub>iss</sub>	Input Capacitance	/	3099	/	pF	V <sub>GS</sub> =0V	Fig.11
C <sub>oss</sub>	Output Capacitance	/	55	/		V <sub>DS</sub> =1000V	
C <sub>rss</sub>	Reverse Transfer Capacitance	/	5.2	/		f=1MHz	
E <sub>oss</sub>	C <sub>oss</sub> Stored Energy	/	36	/	μJ	V <sub>AC</sub> =25mV	Fig.12
E <sub>ON</sub>	Turn- On Switching Energy	/	437	/	μJ	V <sub>DS</sub> =1700V, V <sub>GS</sub> =-5V/20V	Fig.22,26
E <sub>OFF</sub>	Turn- Off Switching Energy	/	140	/		I <sub>D</sub> =15A, R <sub>g</sub> =8Ω, L=220μH	
t <sub>d(on)</sub>	Turn- On Delay Time	/	82	/	ns	V <sub>DS</sub> =1700V, V <sub>GS</sub> =-5V/20V, I <sub>D</sub> =15A R <sub>g</sub> =8Ω, L=220μH	Fig.24
t <sub>r</sub>	Rise Time	/	28	/			
t <sub>d(off)</sub>	Turn- Off Delay Time	/	33	/			
t <sub>f</sub>	Fall Time	/	18	/			
R <sub>G(int)</sub>	Internal Gate Resistance	/	1.3	/	Ω	f=1MHz, V <sub>AC</sub> =25mV	
Q <sub>GS</sub>	Gate to Source Charge	/	41	/	nC	V <sub>DS</sub> =1000V	Fig.10
Q <sub>GD</sub>	Gate to Drain Charge	/	43	/		V <sub>GS</sub> =-5V/20V	
Q <sub>G</sub>	Total Gate Charge	/	130	/		I <sub>D</sub> =15A	

## Reverse Diode Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
V <sub>SD</sub>	Diode Forward Voltage	4.0	/	V	V <sub>GS</sub> =-5V, I <sub>F</sub> =7A	Fig. 17-18
		3.4	/		V <sub>GS</sub> =-5V, I <sub>F</sub> =7A, T <sub>J</sub> =175 °C	
I <sub>S</sub>	Continuous Diode Forward Current	/	33	A	T <sub>C</sub> = 25 °C	
t <sub>rr</sub>	Reverse Recover Time	72	/	ns	V <sub>R</sub> =1700V, I <sub>SD</sub> =15A T <sub>J</sub> =25 °C	
Q <sub>rr</sub>	Reverse Recovery Charge	340	/	nC		
I <sub>rrm</sub>	Peak Reverse Recovery Current	8	/	A		

## Reverse Diode Characteristics

Symbol	Parameter	Typ.	Max.	Unit	Test Conditions	Note
R <sub>θJC</sub>	Thermal Resistance	0.34	0.41	°C/W		Fig.13

Figure1: OutputCharacteristics( $T_j = 25^\circ\text{C}$ )

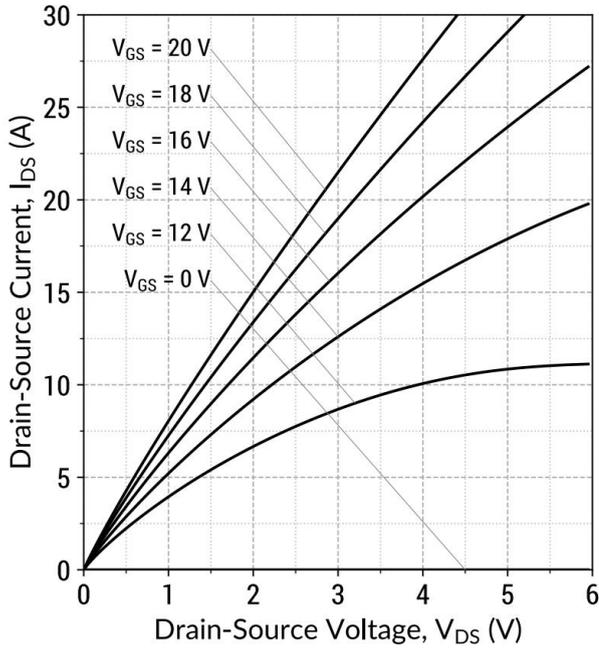


Figure 2: Output Characteristics ( $T_j = 175^\circ\text{C}$ )

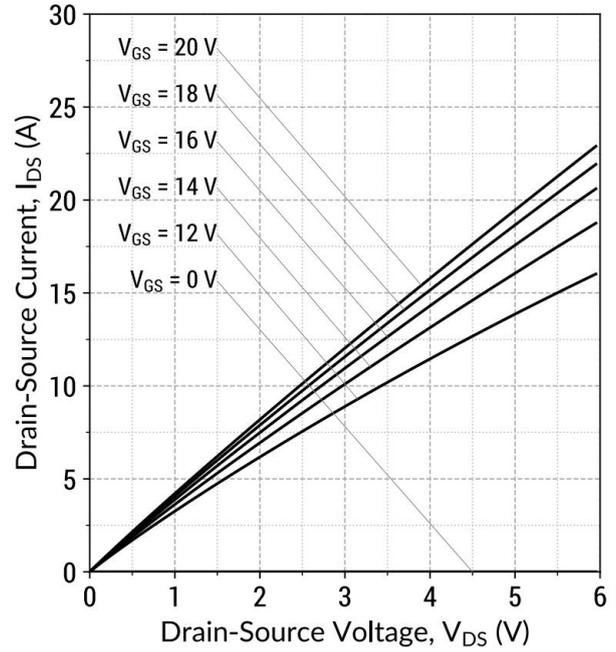


Figure3: OutputCharacteristics( $V_{gs}=20\text{V}$ )

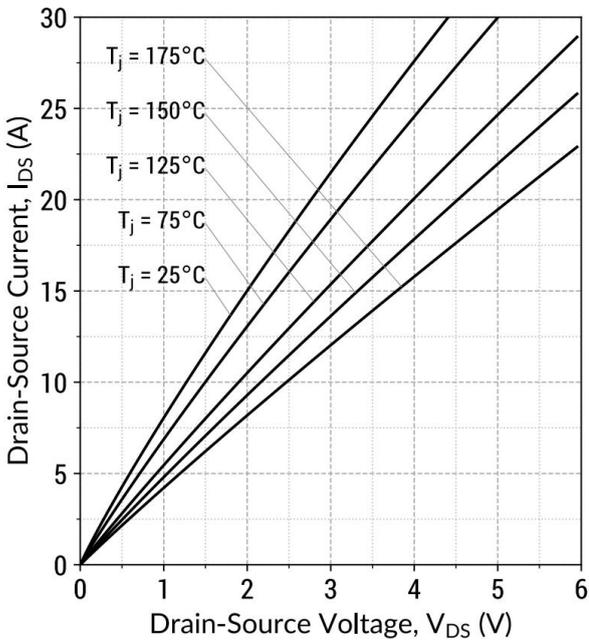


Figure4: TransferCharacteristics( $V_{ds}=10\text{V}$ )

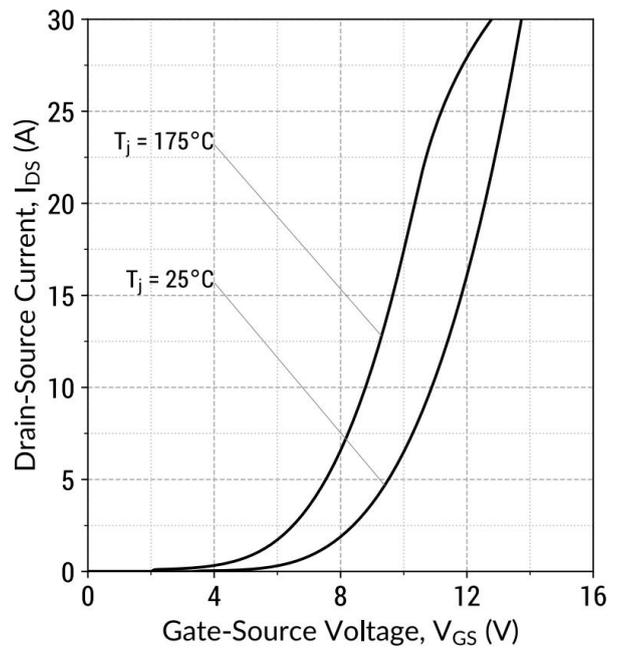


Figure5:On-StateResistance v/s Temperature

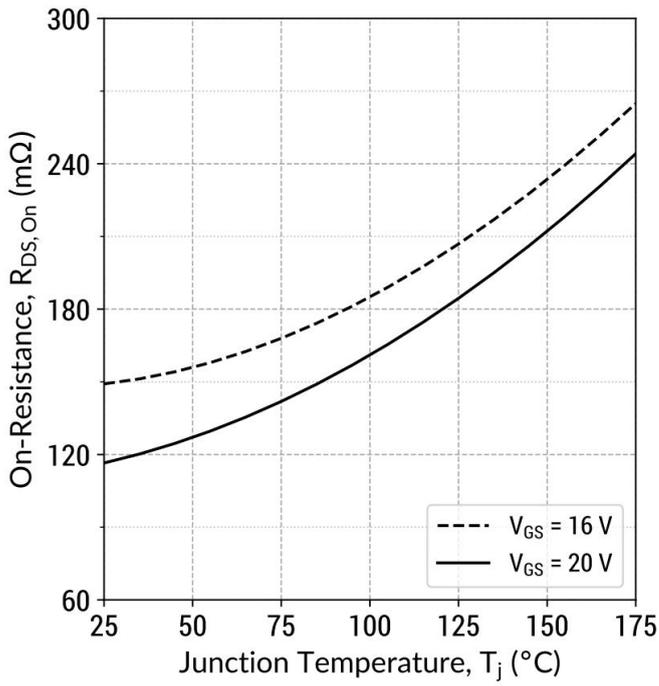


Figure6:On-StateResistance v/s DrainCurrent

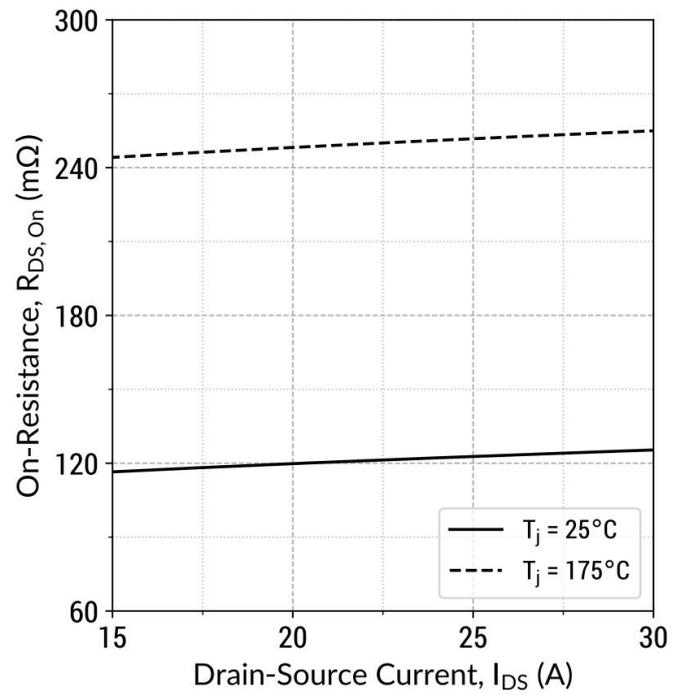


Figure7:NormalizedOn-StateResistance v/s Temperature

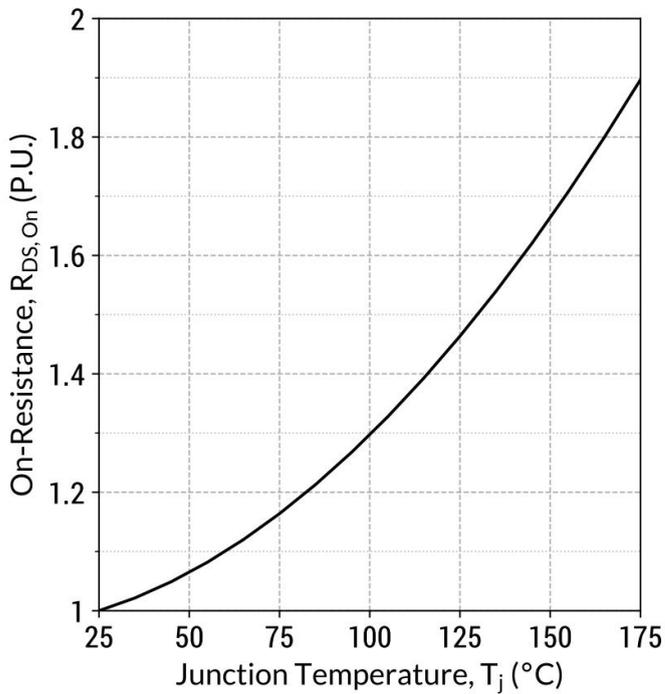


Figure8:On-StateResistance v/s GateVoltage

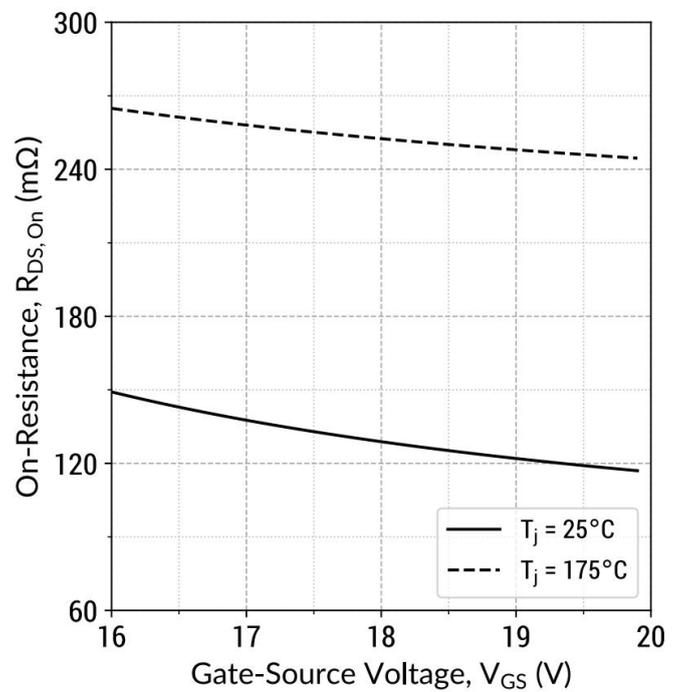


Figure9:ThresholdVoltageCharacteristics

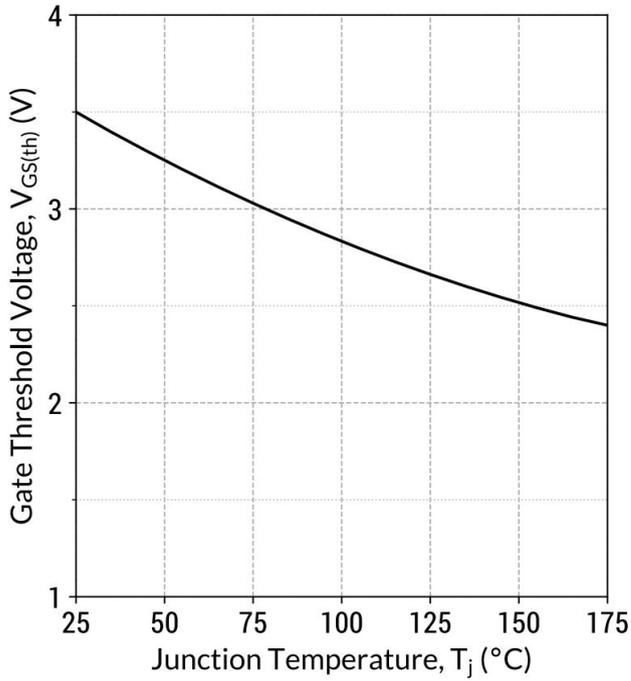


Figure10:GateChargeCharacteristics

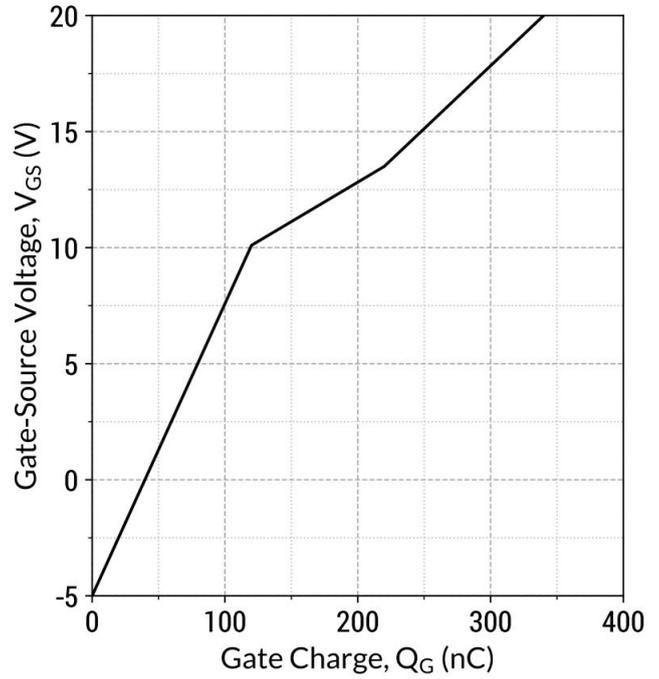


Figure11:CapacitancevsDrain-SourceVoltage

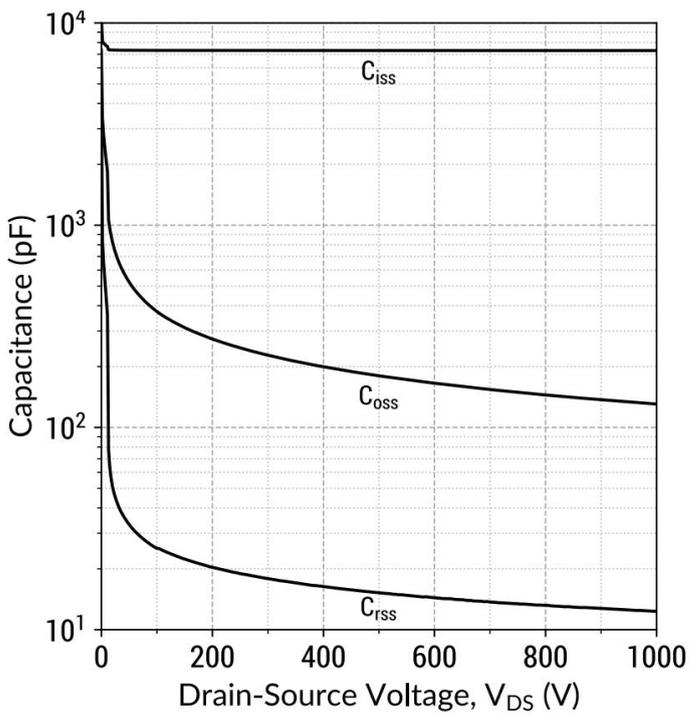


Figure12:OutputCapacitorStoredEnergy

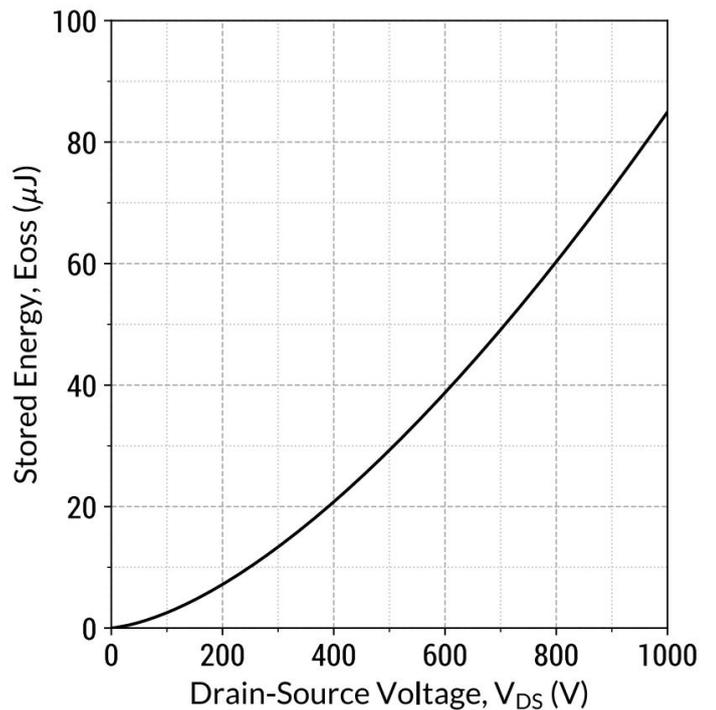


Figure13:TransientThermalImpedance

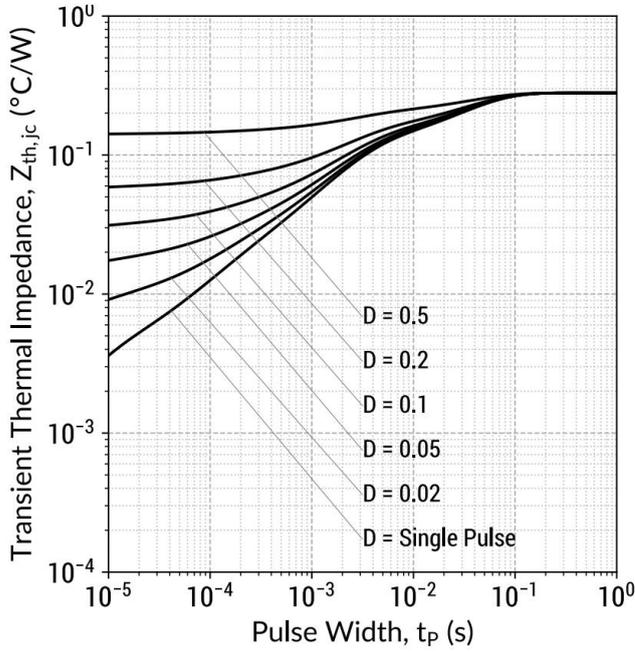


Figure14:SafeOperatingArea( $T_j = 25^{\circ}C$ )

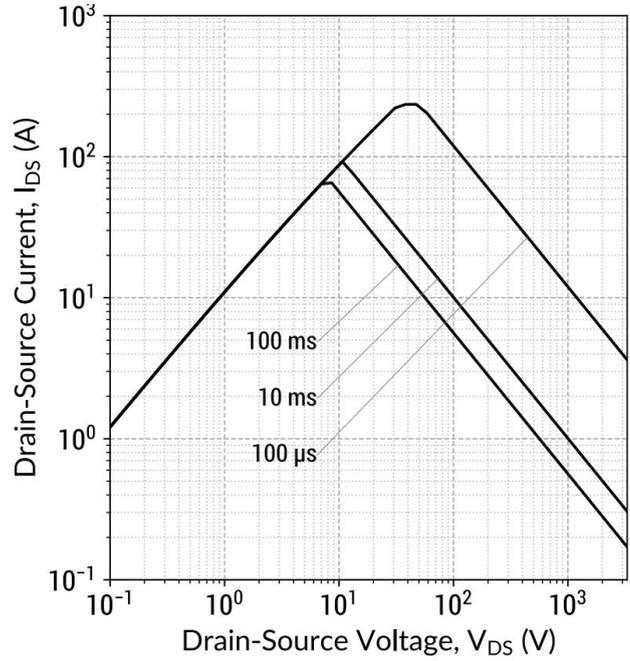


Figure15:CurrentDe-ratingCurve

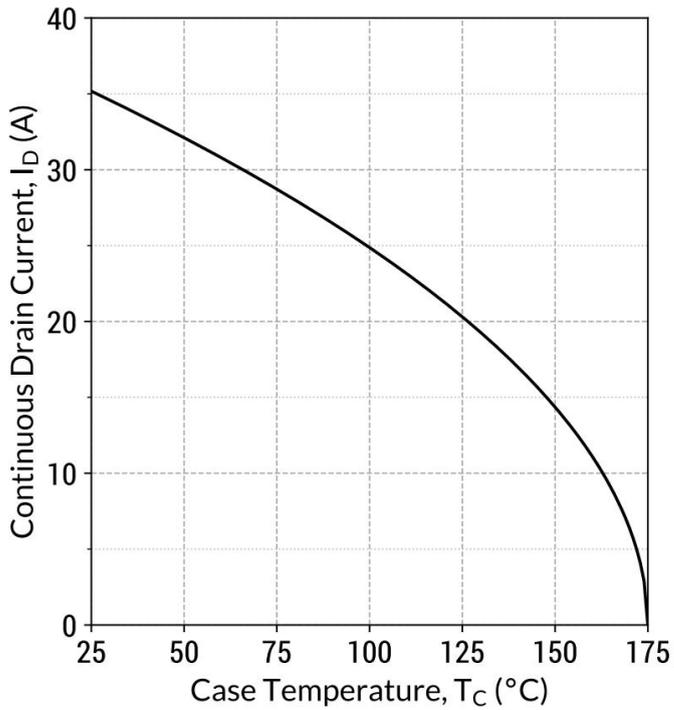


Figure16:PowerDe-ratingCurve

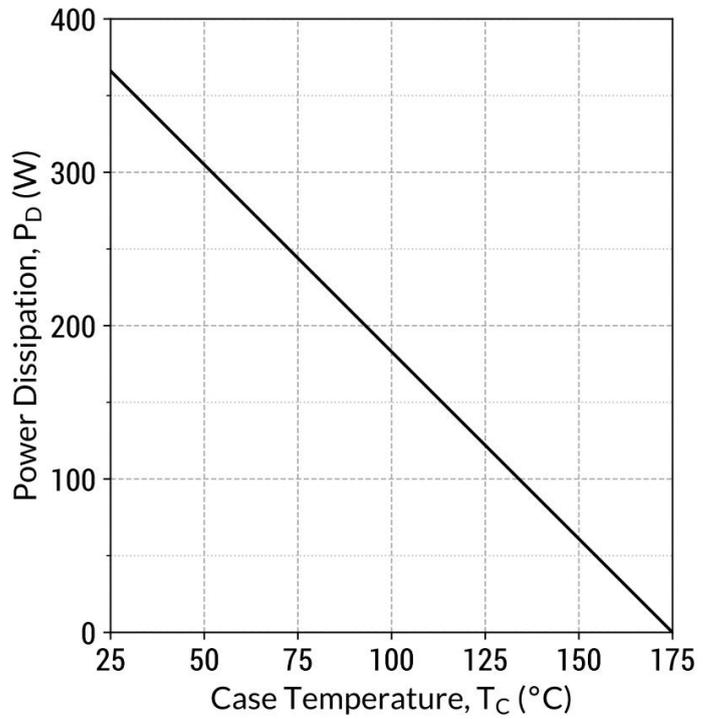


Figure17:BodyDiodeCharacteristics( $T_j=25^\circ\text{C}$ )

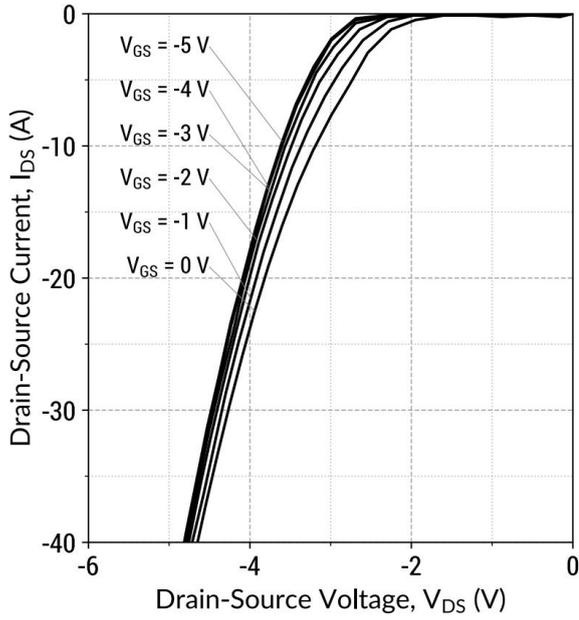


Figure18:BodyDiodeCharacteristics( $T_j=175^\circ\text{C}$ )

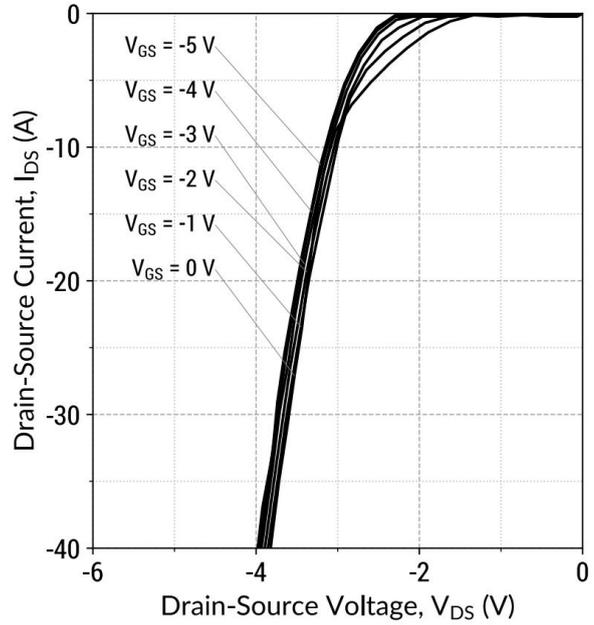


Figure19:ThirdQuadrantCharacteristics( $T_j=25^\circ\text{C}$ )

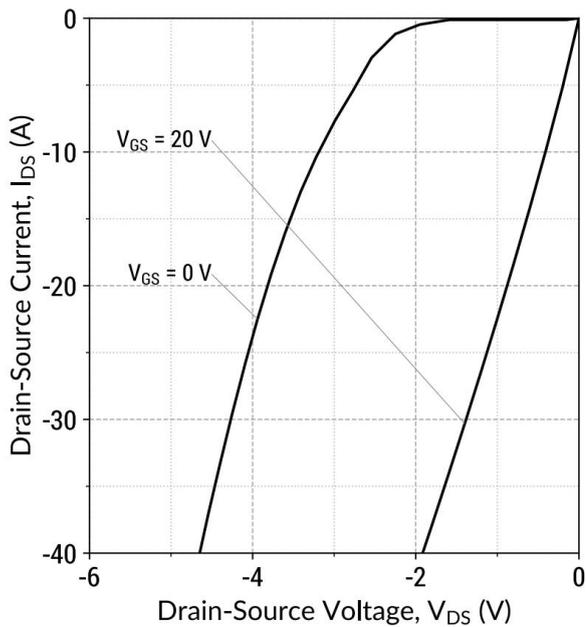


Figure20:ThirdQuadrantCharacteristics( $T_j=175^\circ\text{C}$ )

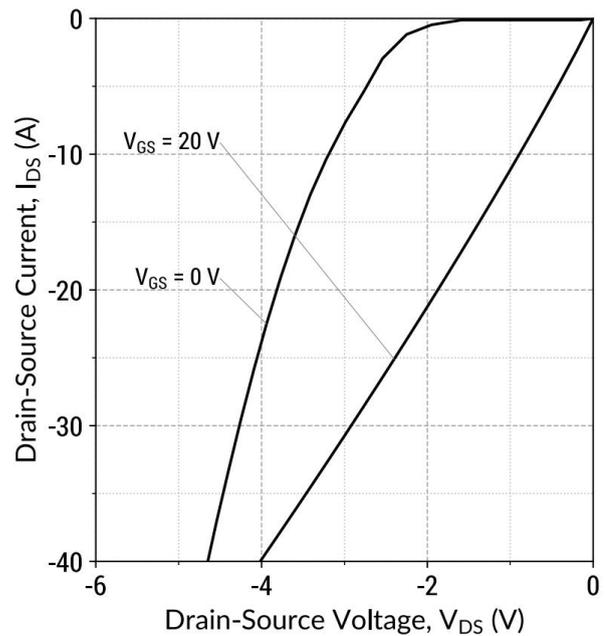


Figure21: Inductive Switching Energy vs Drain Current (V<sub>ds</sub>=1500V)

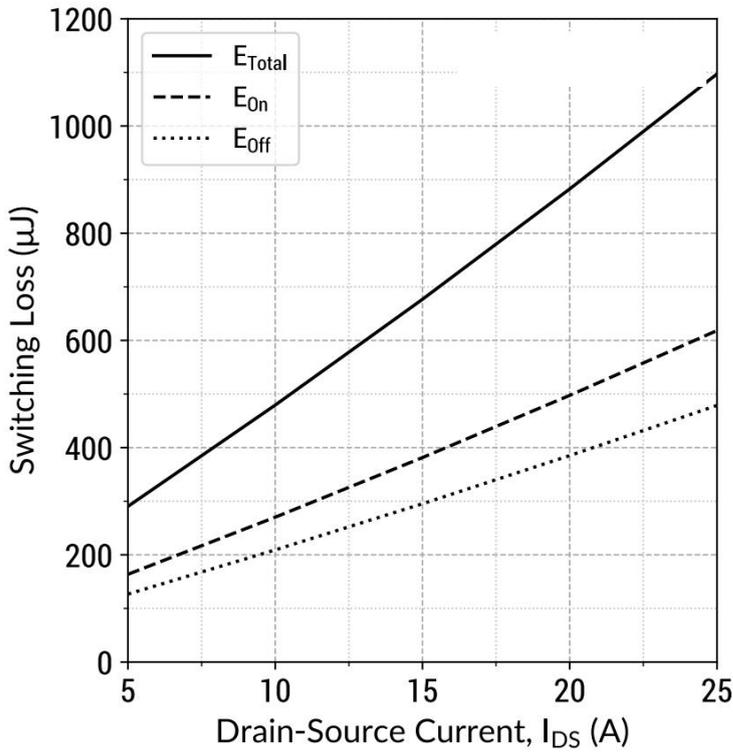


Figure21: Inductive Switching Energy vs Drain Current (V<sub>ds</sub>=1700V)

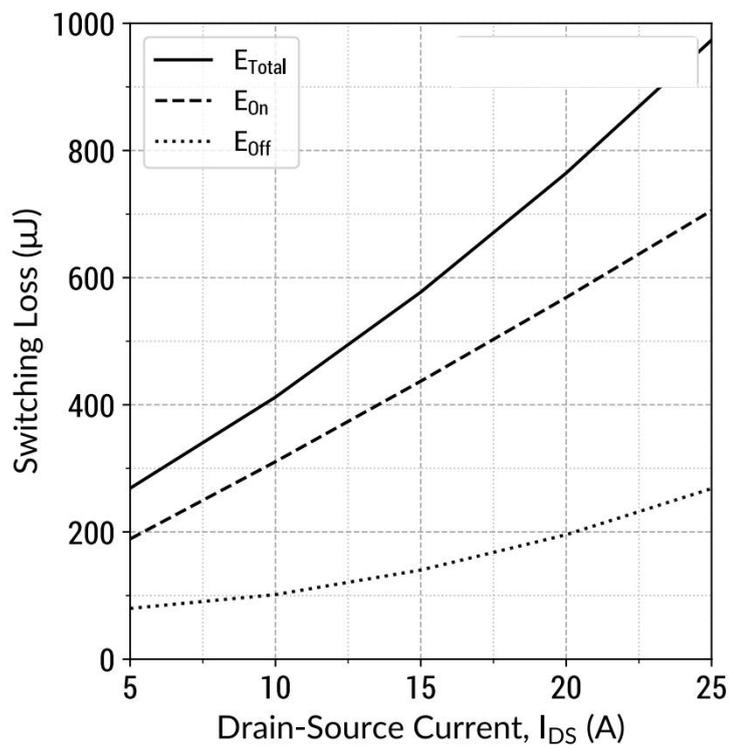


Figure23: Inductive Switching Energy vs Rg (V<sub>ds</sub>=1700V)

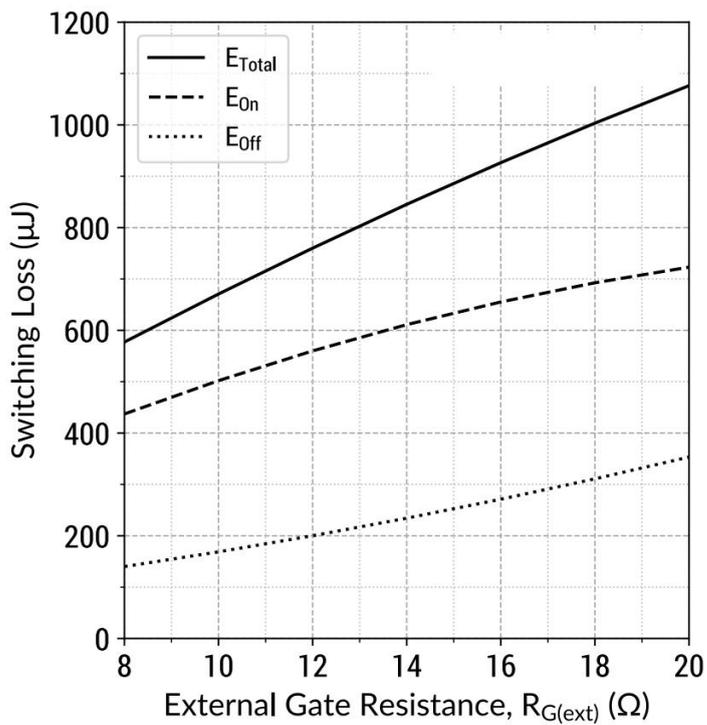


Figure24: Switching Time vs Rg (V<sub>ds</sub>=1700V)

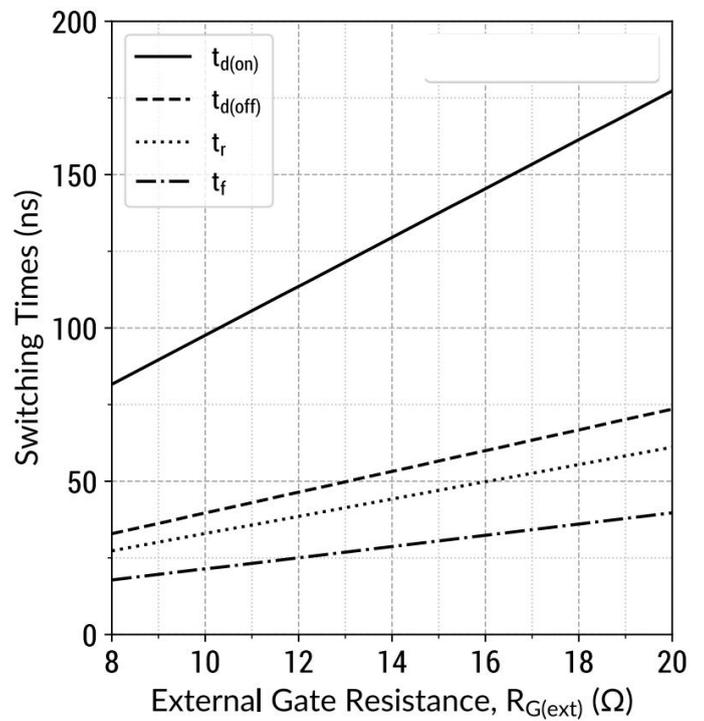


Figure25: Inductive Switching Energy vs Temperature  
( $V_{ds}=1700V$ )

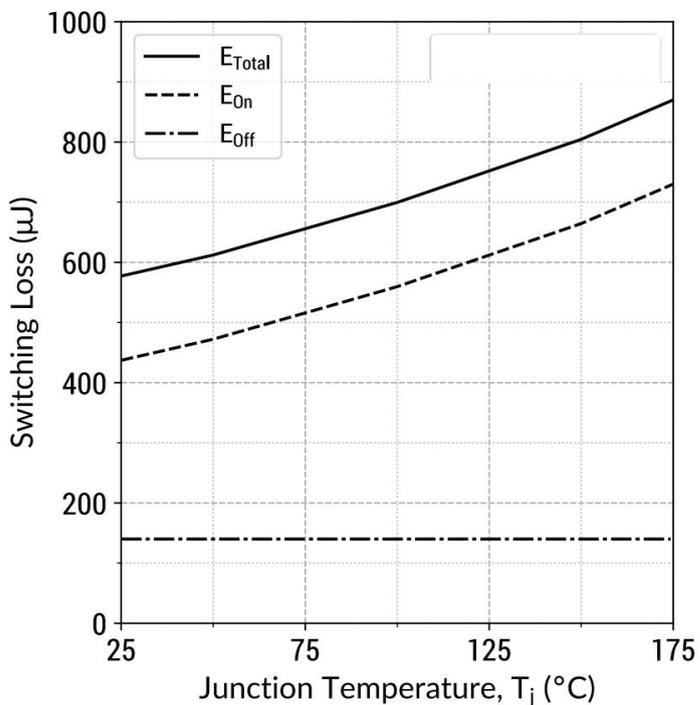


Figure26:  $dV/dt$  vs  $R_g$  ( $V_{ds}=1700V$ )

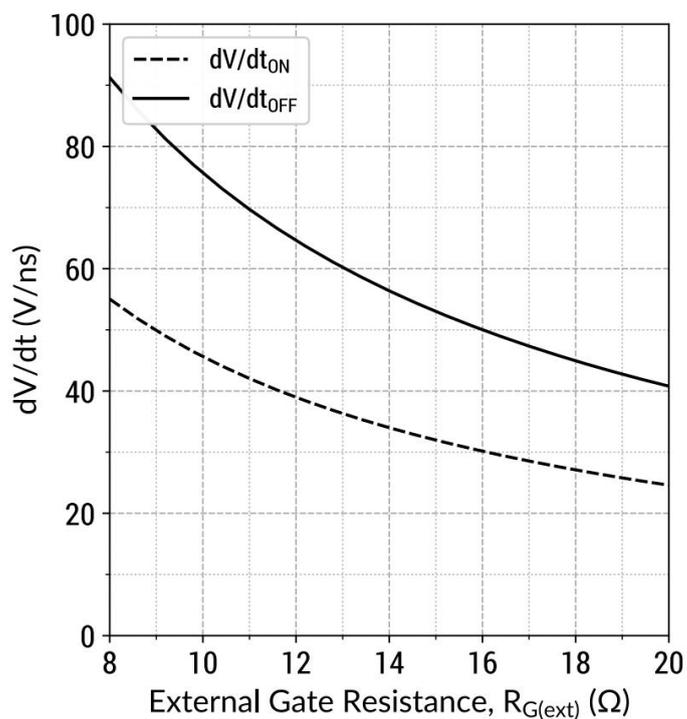
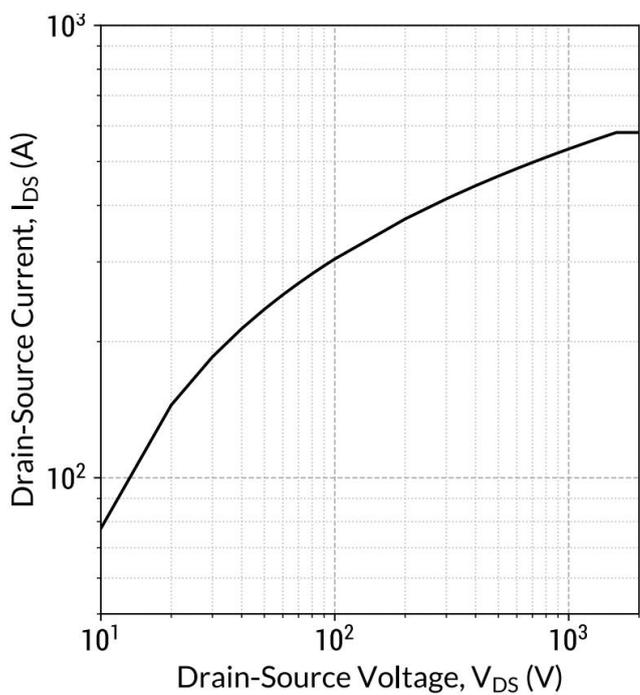
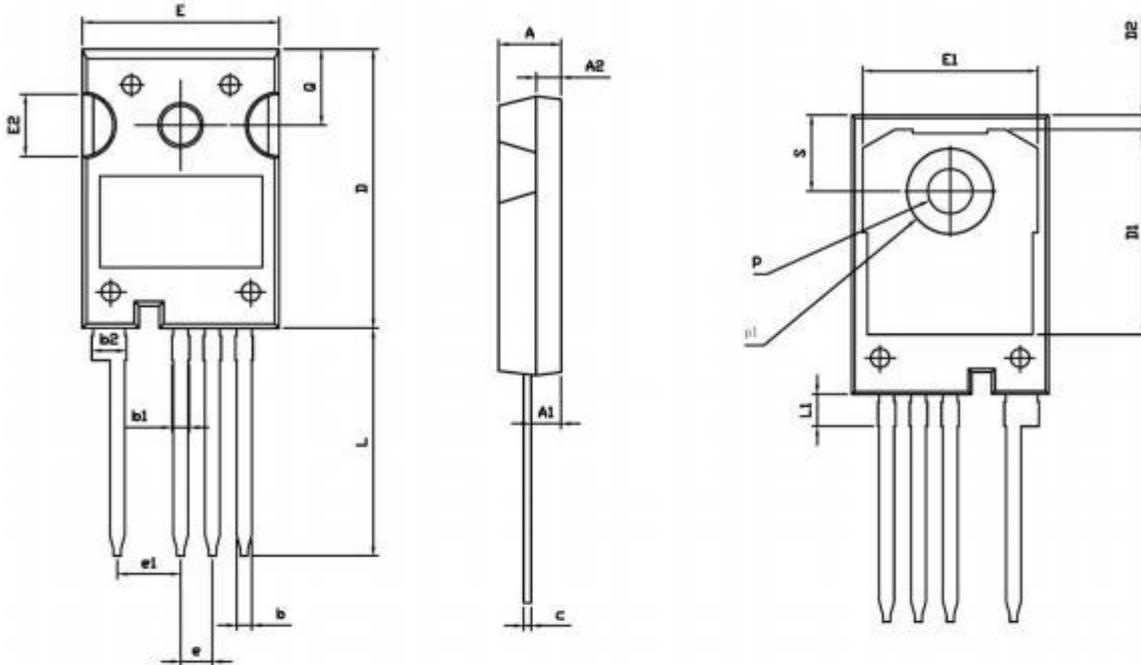


Figure27: High Current IV

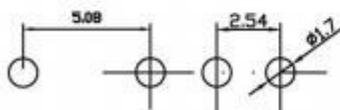


## Package Dimensions

Package TO-247-4



### RECOMMENDED LAND PATTERN



UNIT: mm

	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.25	2.40	2.45
A2	1.85	2.00	2.15
b	1.05	1.20	1.35
b1	1.00	1.30	1.60
b2	2.35	2.65	2.95
c	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.50	17.00
D2	0.97	1.17	1.37
e	2.34	2.54	2.74
e1	4.88	5.08	5.28
E	15.60	15.80	16.00
E1	13.50	14.00	14.50
E2	4.80	5.00	5.20
L	18.08	18.38	18.68
L1	2.38	2.58	2.78
p	3.50	3.60	3.70
p1	6.60	6.80	7.00
Q	6.00	6.15	6.30
S	6.00	6.15	6.30